EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L15	2	("20040048410").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/07/03 10:51
L16	42	(Patrice near Gamand)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 12:40
L17	0	(douvres near delivrande)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 12:40
S1	27581751	@ad<"20031114"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:02
S2	101491	S1 and "438"/$.ccls. and "257"/$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:04
S3	734	S2 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:05
S4	2	("20070134838").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/04/22 16:05
S5	48	S3 and (dop$3 with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:11

S6	2	S3 and ("argon" with (trench or hole$2 or recess $3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:16
S7	319	S1 and "257"/118,244,328-333,466,513,594.ccls. and "438"/242,268-274.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:18
S8	11	S7 and (first near doping)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:19
S9	0	S7 and (dop$3 near2 argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S10	0	S7 and (dop$6 with argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S11	3	S7 and (dop$6 same argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S12	95239	S1 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:25
S13	489	S12 and (dop$3 with (trench or hole$2 or recess $3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S14	231	S12 and (dop$3 near5 (trench or hole$2 or recess $3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30

S15	0	S12 and (dop$3 near5 argon near5 (trench or hole $2 or recess$3 or groove $2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S16	0	S12 and (dop$3 with argon with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S17	11	S12 and (dop$3 with boron with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:31
S18	48632	S2 and (trench$2 or hole$2 or pore$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:36
S19	44	S18 and (high near ohmic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:37
S20	376044	@ad<"20031114" and ("257"/$.ccls. or "438"/$. ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:23
S21	3218	S20 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:24
S22	1101	S21 and oxide and (implant $4 or dop$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:35
S23	496	S22 and (argon or boron)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:35

S24	475052	mems	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:45
S25	13387	micro electro mechanical system	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:45
S26	42	(micro-electro-mechanical-system) and (cantilever beam)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:47
S27	69	(micro-electro-mechanical-system) and (resonator)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:49
S28	381	(rf transceiver) and (resonator$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:05
S29	74	(rf transceiver) and (resonator$2) and (dop$4 or implant$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:12
S30	4203	(transceiver) and (mems)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:13
S31	33	(rf transceiver) and (resonator$2) and (dop$4 or implant$4) and mems	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:13
S32	1490	(resonator$2) and (dop$4 or implant$4) and "mems"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:14

S33	1012	(resonator$2) and (dop$4 or implant$4) and "mems" and oxide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:14
S34	754	S33 and electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:15
S35	576	S33 and electrode and (trench or groove or hole or pore)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:15
S36	300	S33 and electrode and (trench or groove)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:16
S37	147	S36 and (argon or boron or "ar" or "br")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:16
S38	9035	@ad<"20031114" and (resonat$5 or cantilever$3) and (doping or implant$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:07
S39	2483	S38 and (trench$3 or groove $3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:07
S40	1715	S39 and etch$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:08
S41	503	S40 and (sacrificial or release)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:08

S42	273176	@ad<"20031114" and (resonat$5 or cantilever$3 or mems)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:37
S43	2926	S42 and ((dop$5 or implant $5) near3 (substrate or trench or groove))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:38
S44	2265	S42 and ((dop$5 or implant $5) near2 (substrate or trench or groove))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:38
S45	758	S42 and (((dop$5 or implant $5) near2 (substrate or trench or groove)) same (oxide or insulat$5 or dielectric))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:39
S46	277	S42 and (((dop$5 or implant $5) near2 (substrate or trench or groove)) same (oxide or insulat$5 or dielectric) same (etch$3 or remov$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:39

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